SONY

CXA3627ER

All Band Tuner IC with On-chip PLL

Description

The CXA3627ER is a monolithic TV tuner IC which integrates local oscillator and mixer circuits for VHF band, local oscillator and mixer circuits for UHF band, an IF amplifier and a tuning PLL onto a single chip, enabling further miniaturization of the tuner by adopting a small package.

Features

- Low power consumption (5V, 63mA typ.)
- Low noise figure, low distortion characteristics
- High gain/low gain selectable
- Supports IF double-tuned/adjacent channel trap
- Balanced oscillator circuits with excellent oscillation stability
- On-chip PLL supports I^{2}C bus
- On-chip high voltage drive transistor for charge pump
- Frequency step selectable from 31.25, 50 or 62.5kHz (when using a 4MHz crystal)
- Low-phase noise synthesizer
- On-chip 4-output band switch (output voltage: 5V, current capacity: 13mA)
- 32-pin VQFN small package
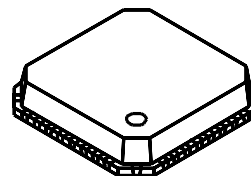- UHF band switch output switchable

Applications

- TV tuners
- VCR tuners
- CATV tuners

Structure

Bipolar silicon monolithic IC

32 pin VQFN (Plastic)

Absolute Maximum Ratings

- Supply voltage   Vcc   −0.3 to +5.5   V
- Operating temperature   Topr   −25 to +75   °C
- Storage temperature   Tstg   −55 to +150   °C
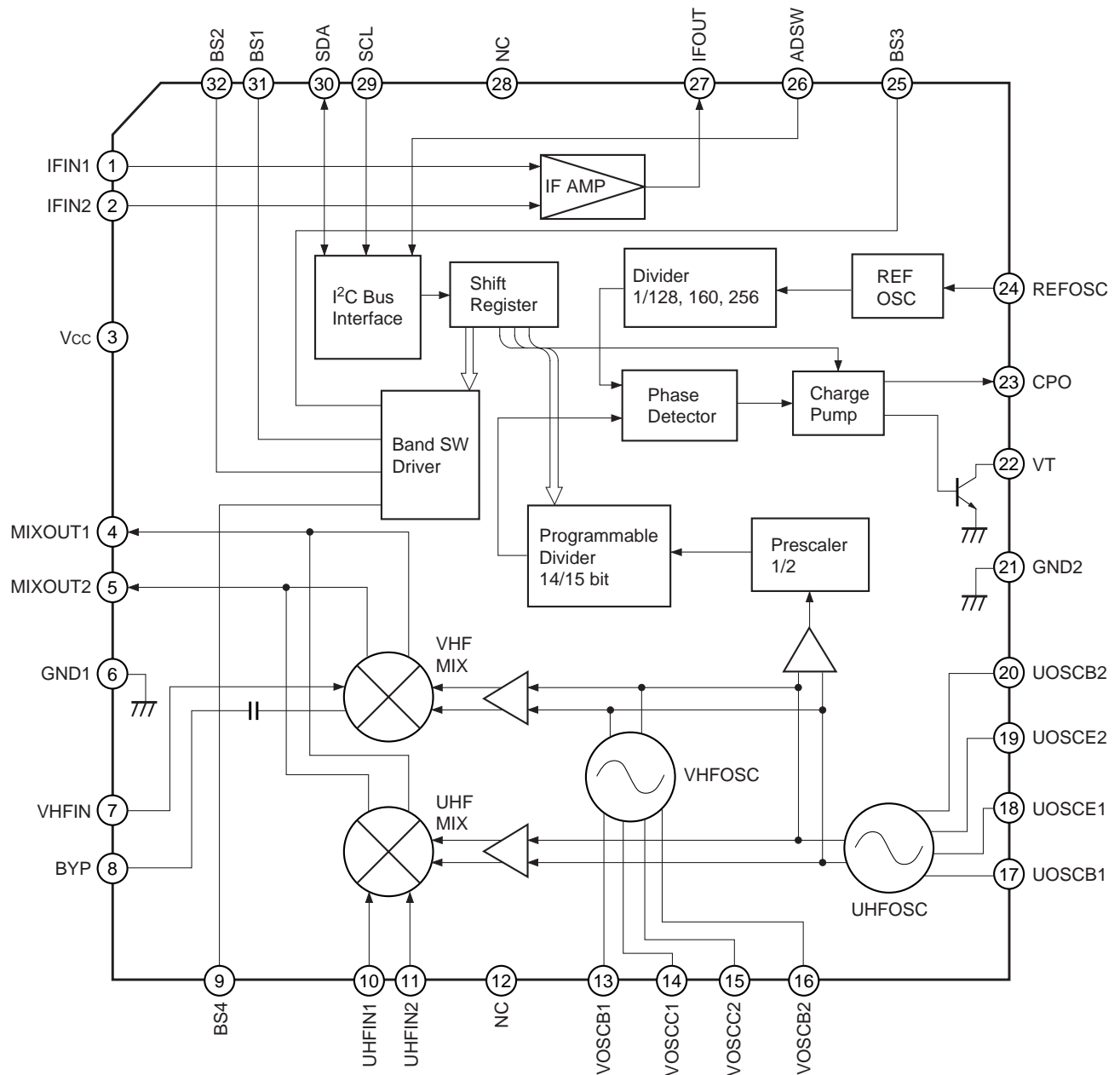- Allowable power dissipation

                      Pd   610   mW

Operating Conditions

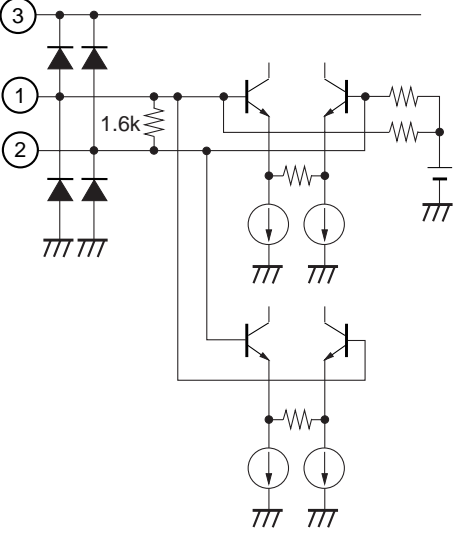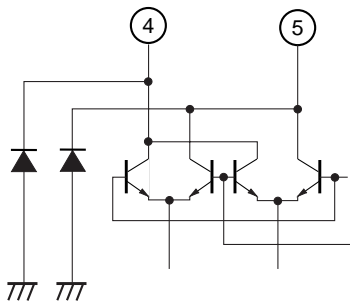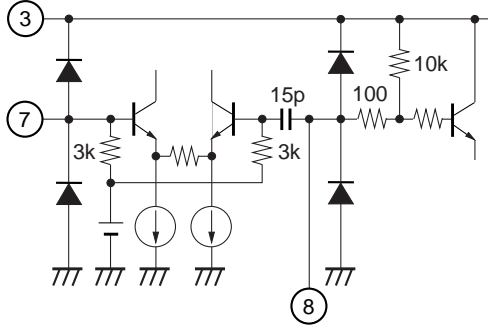Supply voltage   Vcc   4.75 to 5.30   V

Note: This IC has pins whose electrostatic discharge strength is weak as the operating frequency is high and the high-frequency process is used for this IC. Take care of handling the IC.
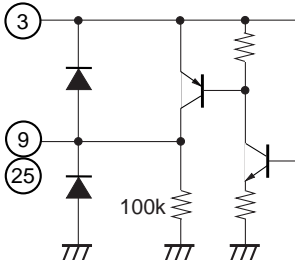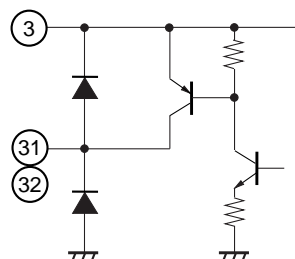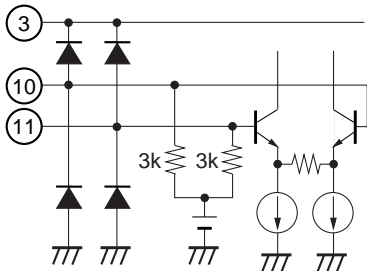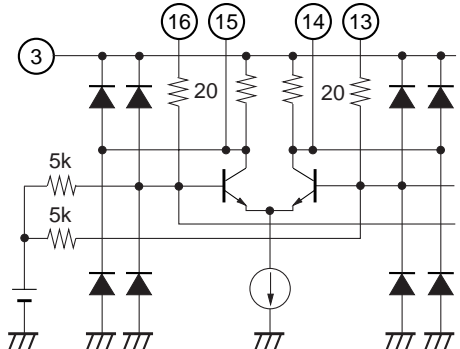
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Block Diagram and Pin Configuration

Pin Description

Pin No.	Symbol	Pin voltage [V]	Equivalent circuit	Description
1	IFIN1	2.0		IF inputs. These pins must be connected to the mixer outputs via coupling capacitance.
2	IFIN2			
3	Vcc	—	—	Power supply.
4	MIXOUT1	—		Mixer outputs. These pins output the signal in open collector format, and they must be connected to the power supply via a load.
5	MIXOUT2			
6	GND1	—	—	Analog circuit GND.
7	VHFIN	2.4 during VHF reception 0.0 during UHF reception		VHF input. The input format is unbalanced input.
8	BYP	3.8 (when open)		VHF input GND and selection of band switching. GND: BS4 UHF Open: BS3 UHF

Pin No.	Symbol	Pin voltage [V]	Equivalent circuit	Description
9	BS4	High: 4.9 Low: 0.0		Band switch outputs. This pin corresponding to the selected band goes High.
25	BS3			
31	BS1			
32	BS2			
10	UHFIN1	0.0 during VHF reception 2.3 during UHF reception		UHF inputs. Input a balanced signal to Pins 14 and 15, or ground either of Pin 14 or 15 with a capacitor and input the signal to the other pin.
11	UHFIN2			
12	NC	—	—	
13	VOSCB1	2.3 during VHF reception 2.5 during UHF reception		External resonance circuit connection for VHF oscillator.
14	VOSCC1	4.0 during VHF reception Vcc during UHF reception		
15	VOSCC2	4.0 during VHF reception Vcc during UHF reception		
16	VOSCB2	2.3 during VHF reception 2.5 during UHF reception		

Pin No.	Symbol	Pin voltage [V]	Equivalent circuit	Description
17	UOSCB1	2.4 during VHF reception 2.2 during UHF reception		External resonance circuit connection for UHF oscillator.
18	UOSCE1	2.0 during VHF reception 1.5 during UHF reception		
19	UOSCE2	2.0 during VHF reception 1.5 during UHF reception		
20	UOSCB2	2.4 during VHF reception 2.2 during UHF reception		
24	GND2	—	—	PLL circuit GND.
22	VT	—		Varicap drive voltage output. This pin outputs the signal in open collector format, and it must be connected to the tuning power supply via a load.
23	CPO	2.0		Charge pump output. Connects the loop filter.
24	REFOSC	4.4		Crystal connection for reference oscillator.
26	ADSW	1.25 (when open)		Address selection. Controls address bits 1 and 2.

Pin No.	Symbol	Pin voltage [V]	Equivalent circuit	Description
27	IFOUT	2.8		IF output.
28	NC	—	—	
29	SCL	—		Clock input.
30	SDA	—		Data input.

Electrical Characteristics (See the Electrical Characteristics Measurement Circuit.)

Circuit Current

(Vcc = 5V, IFVcc = 5V, Ta = 25°C)

Item	Symbol	Measurement conditions	Min.	Typ.	Max.	Unit
Circuit current	Iccv	Vcc current Band switch output open during VHF operation	41	64	88	mA
	Iccu	Vcc current Band switch output open during UHF operation	40	63	87	mA

OSC/MIX/IF Amplifier Block

Item	Symbol	Measurement conditions	Min.	Typ.	Max.	Unit
Conversion gain*1	CG1	VHF operation f_{RF} = 55MHz High gain mode	19.0	22.0	25.0	dB
	CG2	VHF operation f_{RF} = 360MHz High gain mode	19.5	22.5	25.5	dB
	CG3	UHF operation f_{RF} = 360MHz High gain mode	23.0	26.0	29.0	dB
	CG4	UHF operation f_{RF} = 800MHz High gain mode	23.0	26.0	29.0	dB
	CG5	VHF operation f_{RF} = 55MHz Low gain mode	17.0	20.0	23.0	dB
	CG6	VHF operation f_{RF} = 360MHz Low gain mode	17.5	20.5	23.5	dB
	CG7	UHF operation f_{RF} = 360MHz Low gain mode	21.0	24.0	27.0	dB
	CG8	UHF operation f_{RF} = 800MHz Low gain mode	21.0	24.0	27.0	dB
Noise figure*1, *2	NF1	VHF operation f_{RF} = 55MHz High gain mode		12	15	dB
	NF2	VHF operation f_{RF} = 360MHz High gain mode		12	15	dB
	NF3	UHF operation f_{RF} = 360MHz High gain mode		10	13	dB
	NF4	UHF operation f_{RF} = 800MHz High gain mode		11	14	dB
	NF5	VHF operation f_{RF} = 55MHz Low gain mode		13	16	dB
	NF6	VHF operation f_{RF} = 360MHz Low gain mode		13	16	dB
	NF7	UHF operation f_{RF} = 360MHz Low gain mode		11	14	dB
	NF8	UHF operation f_{RF} = 800MHz Low gain mode		12	15	dB
1% cross modulation 1*1, *3	CM1	VHF operation f_D = 55MHz f_{UD} = ±12MHz (30% AM) High gain mode	99	103		dBμ
	CM2	VHF operation f_D = 360MHz f_{UD} = ±12MHz (30% AM) High gain mode	99	103		dBμ
	CM3	UHF operation f_D = 360MHz f_{UD} = ±12MHz (30% AM) High gain mode	97	101		dBμ
	CM4	UHF operation f_D = 800MHz f_{UD} = ±12MHz (30% AM) High gain mode	94	98		dBμ
	CM5	VHF operation f_D = 55MHz f_{UD} = ±12MHz (30% AM) Low gain mode	100	104		dBμ
	CM6	VHF operation f_D = 360MHz f_{UD} = ±12MHz (30% AM) Low gain mode	100	104		dBμ
	CM7	UHF operation f_D = 360MHz f_{UD} = ±12MHz (30% AM) Low gain mode	98	102		dBμ
	CM8	UHF operation f_D = 800MHz f_{UD} = ±12MHz (30% AM) Low gain mode	94	98		dBμ
Maximum output power	Pomax	50Ω load, saturation output	8	11		dBm

Item	Symbol	Measurement conditions	Min.	Typ.	Max.	Unit
Switch ON drift (PLL not operating) *4	Δfsw1	VHF operation fosc = 100MHz Δf from 3s to 3min after switch ON			±200	kHz
	Δfsw2	VHF operation fosc = 405MHz Δf from 3s to 3min after switch ON			±650	kHz
	Δfsw3	UHF operation fosc = 405MHz Δf from 3s to 3min after switch ON			±350	kHz
	Δfsw4	UHF operation fosc = 845MHz Δf from 3s to 3min after switch ON			±400	kHz
Supply voltage drift (PLL not operating) *4	Δfst1	VHF operation fosc = 100MHz Δf when Vcc 5V changes ±5%			±100	kHz
	Δfst2	VHF operation fosc = 405MHz Δf when Vcc 5V changes ±5%			±350	kHz
	Δfst3	UHF operation fosc = 405MHz Δf when Vcc 5V changes ±5%			±100	kHz
	Δfst4	UHF operation fosc = 845MHz Δf when Vcc 5V changes ±5%			±100	kHz
Oscillator phase noise	C/N1	VHF operation 10kHz offset CP = 1 Phase comparison frequency = 31.25kHz	80			dBc/Hz
	C/N2	UHF operation 10kHz offset CP = 1 Phase comparison frequency = 31.25kHz	80			dBc/Hz

*1 Value measured with untuned input.

*2 NF meter direct-reading value (DSB measurement).

*3 Value with a desired reception signal input level of −30dBm, an interference signal of 100kHz/30% AM, and an interference signal level where S/I = 46dB measured with a spectrum analyzer.
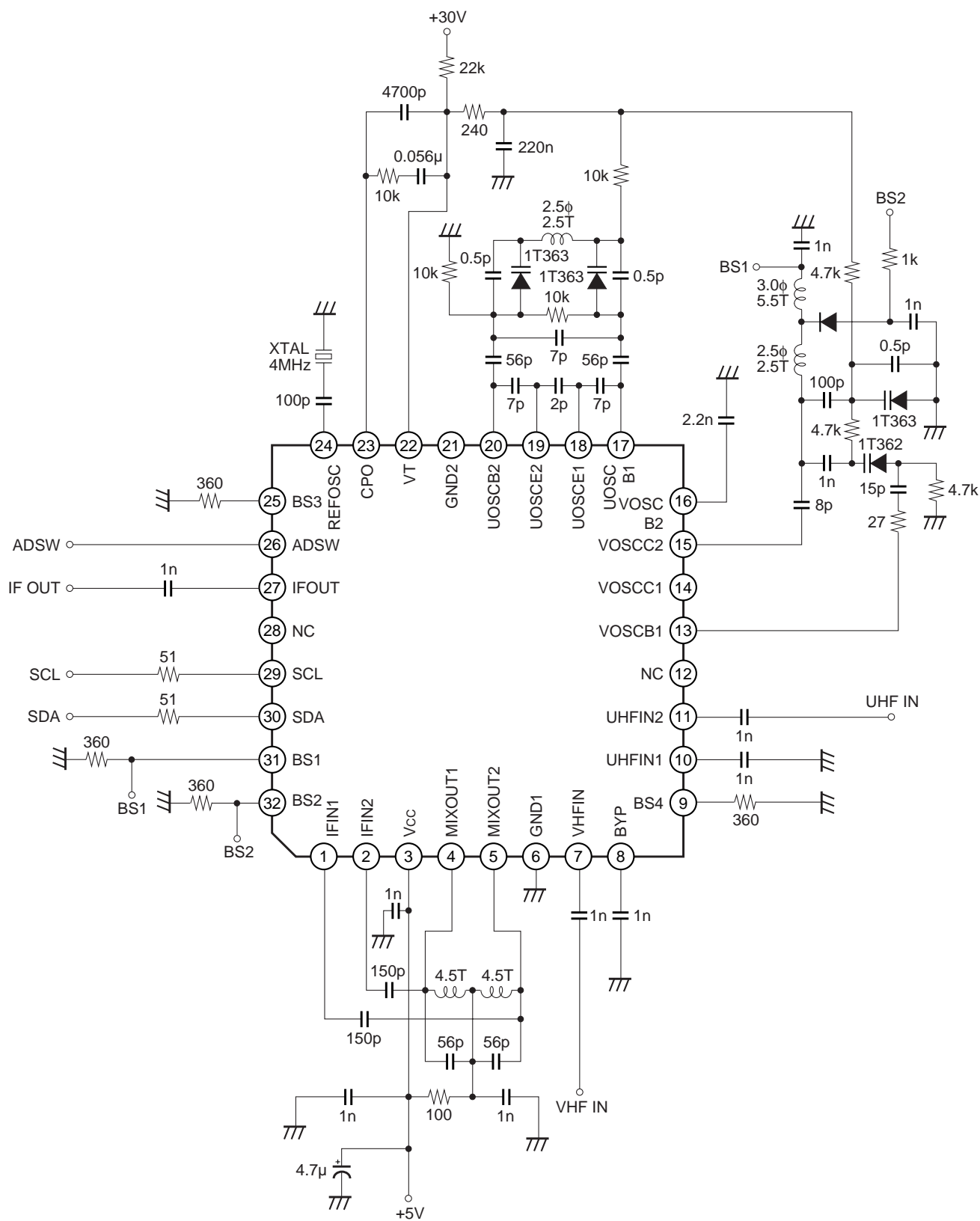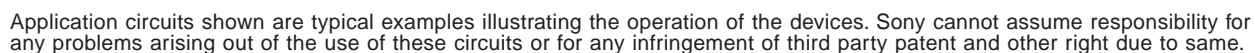
*4 Value when the PLL is not operating.

PLL Block

Item	Symbol	Measurement conditions	Min.	Typ.	Max.	Unit
Lock-up time	LUT1	VHF operation CP = 1 f_{OSC} 100MHz ↔ f_{OSC} 405MHz			50	ms
	LUT2	UHF operation CP = 1 f_{OSC} 405MHz ↔ f_{OSC} 845MHz			50	ms
Reference leak	REFL	Phase comparison frequency = 31.25kHz CP = 1	50			dBc
CL and DA inputs						
"H" level input voltage	V_{IH}		3		Vcc	V
"L" level input voltage	V_{IL}		GND		1.5	V
"H" level input current	I_{IH}	V_{IH} = Vcc		0	−0.1	µA
"L" level input current	I_{IL}	V_{IL} = GND		−0.2	−4	µA
AD input						
"H" level input voltage	V_{IH}		3		Vcc	V
"L" level input voltage	V_{IL}		GND		1	V
"H" level input current	I_{IH}	V_{IH} = Vcc		100	200	µA
"L" level input current	I_{IL}	V_{IL} = GND		−35	−100	µA
SDA output						
"H" output leak current	I_{SDALK}	V_{IN} = 5.5V			5	µA
"L" output voltage	V_{SDAL}	Sink = −3mA	GND		0.4	V
CPO (charge pump)						
Output current 1	I_{CPO1}	When CP = 0 is selected	±30	±50	±80	µA
Leak current 1	LeakCP1	When CP = 0 is selected			30	nA
Output current 2	I_{CPO2}	When CP = 1 is selected	±120	±200	±320	µA
Leak current 2	LeakCP2	When CP = 1 is selected			100	nA
VT (VC voltage output)						
Maximum output voltage	V_{TH}				34	V
Minimum output voltage	V_{TL}	Sink current = 1mA		0.15	0.8	V
REFOSC						
Oscillation frequency range	F_{XTOSC}		3		12	MHz
Input capacitance	C_{XTOSC}		22	24	26	pF
Negative resistance	R_{NEG}	Crystal source impedance f_{REF} = 4MHz	−1	−3		kΩ
Band SW						
Output current	I_{BS}	When ON			−13	mA
Saturation voltage	V_{SAT}	When ON Source current = 13mA		250	330	mV
Leak current	LeakBS	When OFF IFVcc = 5.5V		0.5	3	µA

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Item	Symbol	Measurement conditions	Min.	Typ.	Max.	Unit
Bus timing (I²C bus)						
SCL clock frequency	f_{SCL}		0		400	kHz
Start waiting time	$t_{W;STA}$		1300			ns
Start hold time	$t_{H;STA}$		600			ns
Low hold time	t_{LOW}		1300			ns
High hold time	t_{HIGH}		600			ns
Start setup time	$t_{S;STA}$		600			ns
Data hold time	$t_{H;DAT}$		0		900	ns
Data setup time	$t_{S;DAT}$		600			ns
Rise time	t_R				300	ns
Fall time	t_F				300	ns
Stop setup time	$t_{S;STO}$		600			ns

Electrical Characteristics Measurement Circuit

Application Circuit

Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

Description of Functions

The CXA3627ER is the terrestrial TV broadcasting tuner IC which converts frequencies to IF in order to tune and detect only the desired reception frequency of VHF and UHF band signals.

In addition to the mixer, local oscillation and IF amplifier circuits required for frequency conversion to IF, this IC also integrates a PLL circuit for local oscillation frequency control onto a single chip.

The functions of the various circuits are described below.

1. Mixer circuit

This circuit outputs the frequency difference between the signal input to VHFIN or UHFIN and the local oscillation signal.

2. Local oscillation circuit

A VCO is formed by externally connecting an LC resonance circuit composed of a varicap diode and inductance.

3. IF amplifier circuit

This circuit amplifies the mixer IF output, and consists of an amplifier stage and low impedance output stage.

4. PLL circuit

This PLL circuit fixes the local oscillation frequency to the desired frequency. It consists of a programmable divider, reference divider, phase comparator, charge pump and reference oscillator. The control format supports the I^2C bus format.

The frequency steps of 31.25, 50 or 62.5kHz can be selected by the I^2C bus data-based reference divider frequency division setting value.

5. Band switch circuit

The CXA3627ER has four sets of built-in PNP transistors for switching between the VL, VH and UHF bands and for switching the FM trap, etc. These PNP transistors can be controlled by the bus data.

The emitters for these PNP transistors are connected to the power supply pin (V_{CC}), and are ON and output 5V when the bus data is "1 (H)".

Two types of relations of the bus data and the IC internal OSC/MIX circuits operation are available as shown below. These relations can be selected by grounding or leaving open Pin 8 (BYP).

BYP: Grounding

Band SW data				MIX circuit		OSC circuit	
BS1	BS2	BS3	BS4	VHF	UHF	VHF	UHF
∗	∗	∗	0	O	X	O	X
∗	∗	∗	1	X	O	X	O

BYP: Open

Band SW data				MIX circuit		OSC circuit	
BS1	BS2	BS3	BS4	VHF	UHF	VHF	UHF
∗	∗	0	∗	O	X	O	X
∗	∗	1	∗	X	O	X	O

∗: Don't care   O: Operating   X: Not operating

Description of Analog Block Operation (See the Electrical Characteristics Measurement Circuit.)

VHF oscillator circuit
• This is the differential amplifier-type oscillator circuit. Pins 13 and 16 are base and Pins 14 and 15 are collector. Pins 13, 15 and Pins 16, 14 have the in-phase input/output relation respectively.
This circuit is oscillated with the positive feedback applied by connecting the output to the input via the coupling capacitor and the feedback capacitor.
Oscillation frequency is varied by connecting an LC parallel resonance circuit including a varicap and controlling the voltage applied to the varicap.

VHF mixer circuit
• The mixer circuit employs a double balanced mixer with little local oscillation signal leakage.
The input format is base input type, with Pin 8 grounded either directly or via a capacitor and the RF signal input to Pin 7.
(Pin 8 can also be used to select VHF/UHF switching mode with the BS3/BS4 data.)
• The RF signal is fed from the oscillator, converted to IF frequency and output from Pins 4 and 5. Pins 4 and 5 are open collectors, so external power feed is necessary. Also, connect single-tuned filters to Pins 4 and 5.

UHF oscillator circuit
• The oscillator circuit is designed so that two collector ground type Colpitts oscillators perform differential oscillation operation via an LC resonance circuit including a varicap.
• Resonance capacitance is connected between Pins 17 and 18, Pins 18 and 19, and Pins 19 and 20, and an LC resonance circuit including a varicap is connected between Pins 17 and 20.

UHF mixer circuit
• This circuit employs a double balanced mixer like the VHF mixer circuit.
The input format is base input type, with Pins 10 and 11 as the RF input pins. The input method can be selected from balanced input consisting of differential input to Pins 10 and 11 or unbalanced input consisting of grounding Pin 10 via a capacitor and input to Pin 11.
• Pins 4 and 5 are the mixer outputs. Pins 4 and 5 are open collectors, so external power feed is necessary. Also, connect single-tuned filters to Pins 4 and 5.

IF amplifier circuit
• Pins 1 and 2 are the IF amplifier inputs, and the input impedance is approximately 1.6kΩ.
• The signals frequency converted by the mixer are output from Pins 4 and 5, and Pins 4 and 5 are connected to Pins 1 and 2 via capacitors. (An adjacent channel trap circuit can be formed by connecting LC parallel circuits in place of capacitors.)
• The signal amplified by the IF amplifier is output from Pin 27. The output impedance is approximately 10Ω.

Description of PLL Block

This IC is controlled by the I^{2}C bus.

The PLL of this IC performs high-speed phase comparison, providing low reference leak and quick lock-up time characteristics.

During power on, the power-on reset circuit operates to initialize the frequency data to all "0" and the band data to all "OFF". Power-on reset is performed when Vcc ≥ 3.2V at room temperature (Ta = 25°C).

1) Address setting

Up to four addresses can be selected by the hardware bit settings, so that multiple PLL can exist within one system.

The responding address can be set according to the ADSW pin voltage.

Address

1	1	0	0	0	MA1	MA0	R/W

Hardware bits

ADSW pin voltage	MA1	MA0
0 to 0.1Vcc	0	0
OPEN or 0.2Vcc to 0.3Vcc	0	1
0.4Vcc to 0.6Vcc	1	0
0.9Vcc to Vcc	1	1

2) Frequency data setting

The VCO lock frequency is obtained according to the following formula.

fosc = 2 × fref × (32M + S)

fosc: local oscillator frequency

fref: phase comparison frequency

M: main divider frequency division ratio

S: swallow counter frequency division ratio

The variable frequency division ranges of M and S are as follows, and are set as binary.

S < M ≤ 1023

0 ≤ S ≤ 31

3) Control format

When performing control for this IC, byte 1 contains the address data, bytes 2 and 3 contain the frequency data, byte 4 contains the control data, and byte 5 contains the band switch data.

These data are latch transferred in the manner of byte 1, byte 2 + byte 3, and byte 4 + byte 5.

When the correct address is received and acknowledged, the data is recognized as frequency data if the first bit of the next byte is "0", and as control data and band switch data if this bit is "1".

Also, when data transmission is stopped part-way, the previously programmed data is valid. Therefore, once the control and band switch data have been programmed, 3-byte commands consisting of the address and frequency data are possible.

Further, even if the I²C bus stop conditions are not met, data can be input by sending the start conditions and the new address.

The control format is as shown in the table below.

Slave Receiver

	MSB							LSB	
Mode	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	
Address byte	1	1	0	0	0	MA1	MA0	0	A
Divider byte1	0	M9	M8	M7	M6	M5	M4	M3	A
Divider byte2	M2	M1	M0	S4	S3	S2	S1	S0	A
Control byte	1	CP	GC	CD	X	R1	R0	OS	A
Band SW byte	X	X	X	X	BS4	BS3	BS2	BS1	A

X: Don't care

A: Acknowledge bit

MA0, MA1: address setting

M0 to: main divider frequency division ratio setting

S0 to: swallow counter frequency division ratio setting

CD: charge pump OFF (when "1")

OS: varicap output OFF (when "1")

CP: charge pump current switching (200μA when "1", 50μA when "0")

GC: gain switching (IC gain reduced by 2dB when "1")

BS1 to BS4: band switch control (output PNP transistor ON when "1")

R0, R1: reference divider frequency division ratio setting (See the Reference Divider Frequency Division Ratio Table.)
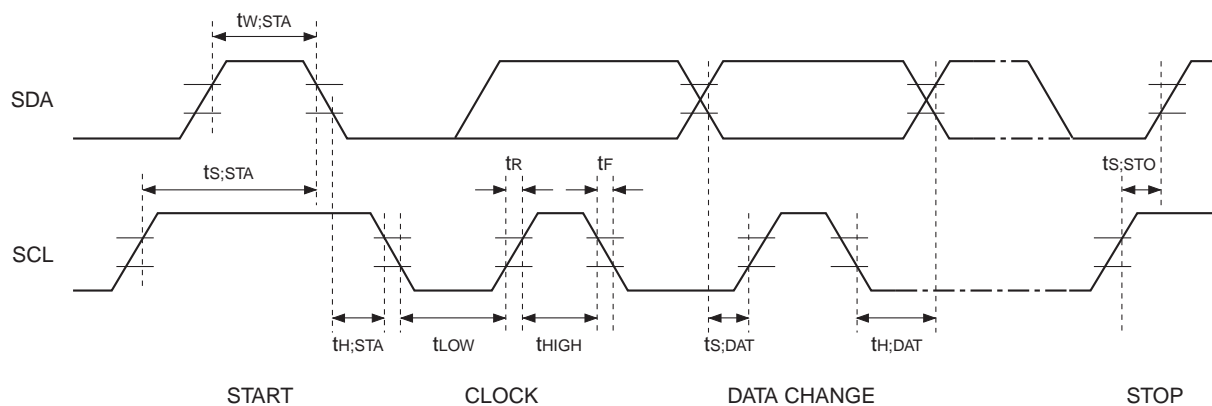
Reference Divider Frequency Division Ratio Table

R1	R0	Reference Divider
0	1	256
1	1	128
X	0	160

X: Don't care

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I²C Bus Timing Chart

ts;STA = Start setup time   ts;DAT = Data setup time
tw;STA = Start waiting time   tH;DAT = Data hold time
tH;STA = Start hold time   ts;STO = Stop setup time
tLOW   = Low clock pulse width   tR   = Rise time
tHIGH = High clock pulse width   tF   = Fall time

Example of Representative Characteristics

Circuit current vs. Supply voltage

Band SW output voltage vs. Output current (BS1, BS2, BS3, BS4)

Vcc = 5V

Conversion gain vs. Reception frequency (Untuned input)

fIF = 45MHz
High gain mode

UHF

VHF (High)

VHF (Low)

Noise figure vs. Reception frequency (Untuned input, in DSB)
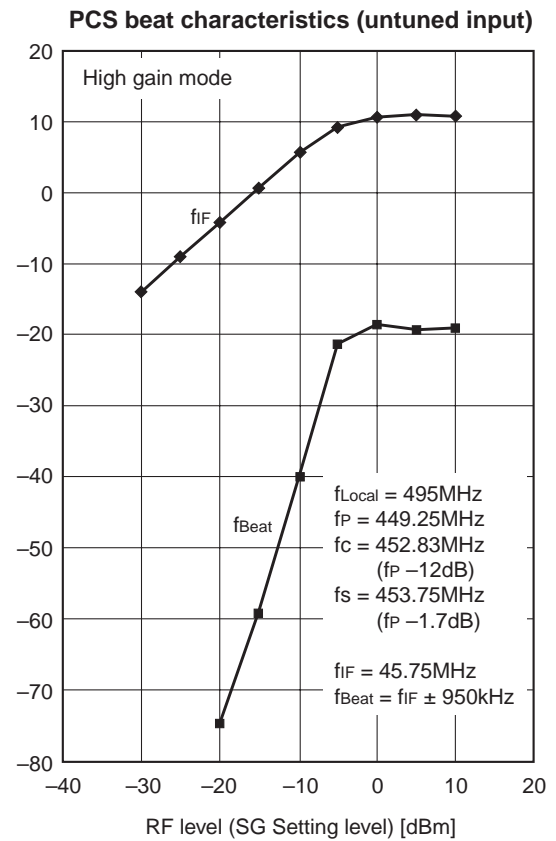
fIF = 45MHz
High gain mode

VHF (High)

VHF (Low)

UHF
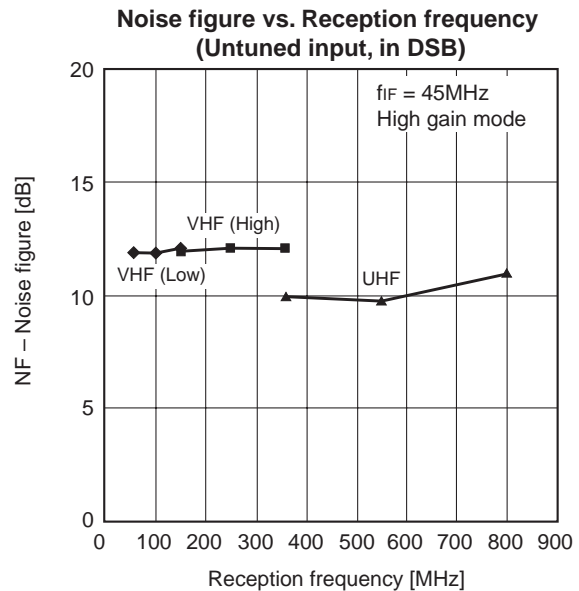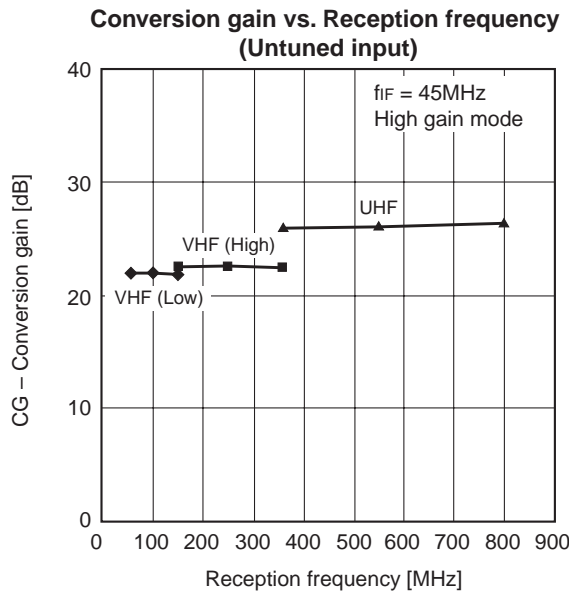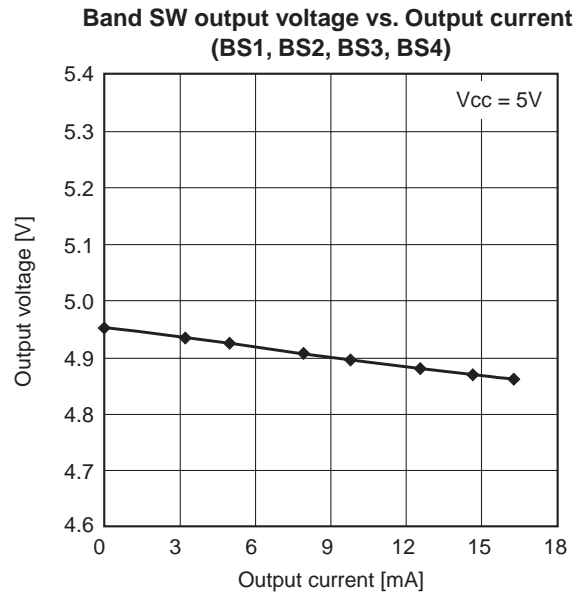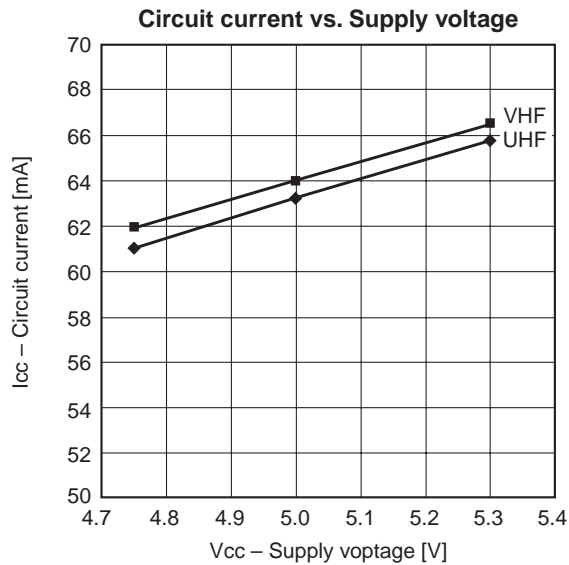
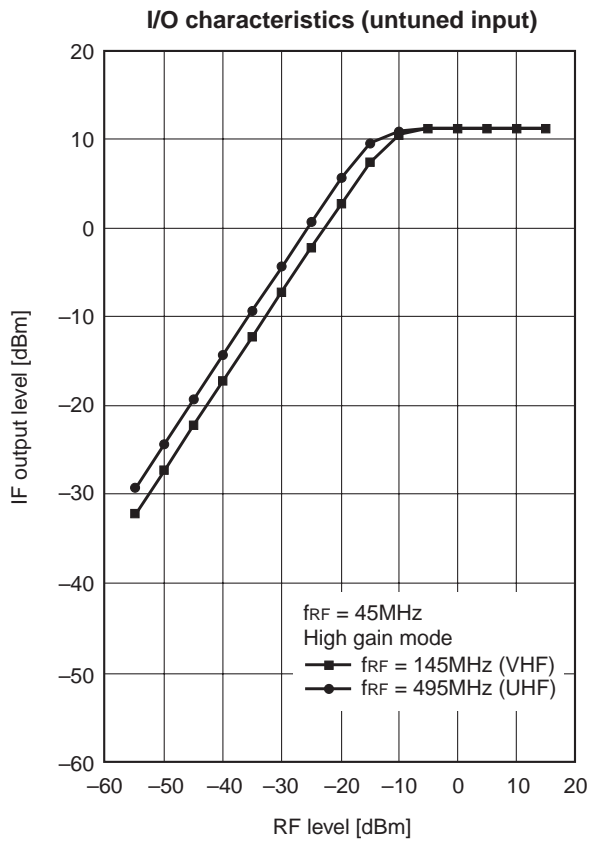### Next adjacent cross modulation vs. Reception frequency (Untuned input)

VHF (High)

UHF

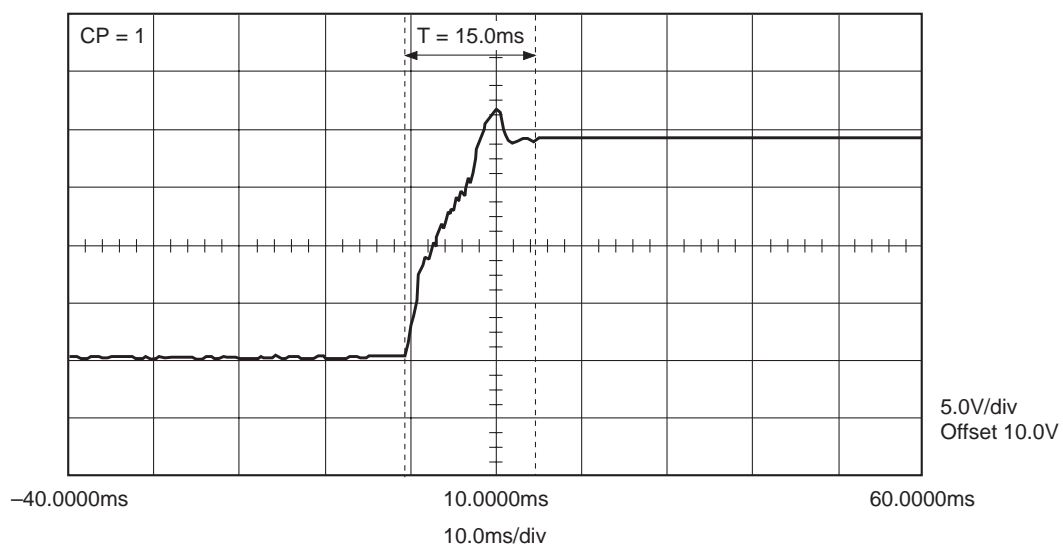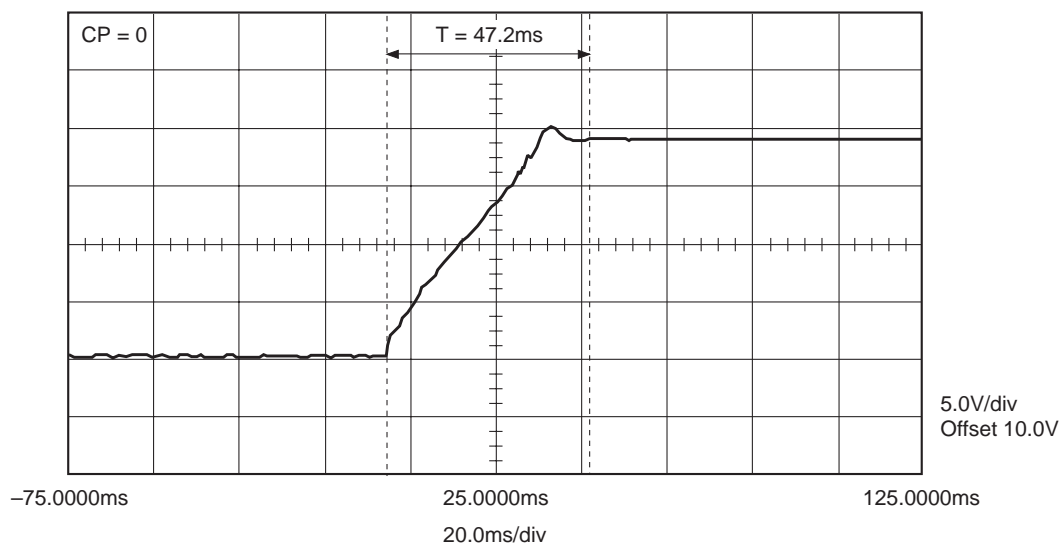VHF (Low)

$f_{UD} = f_D + 12\text{MHz}$
$f_{UD} = f_D - 12\text{MHz}$
(100kHz, 30% AM)

fIF = 45MHz
High gain mode
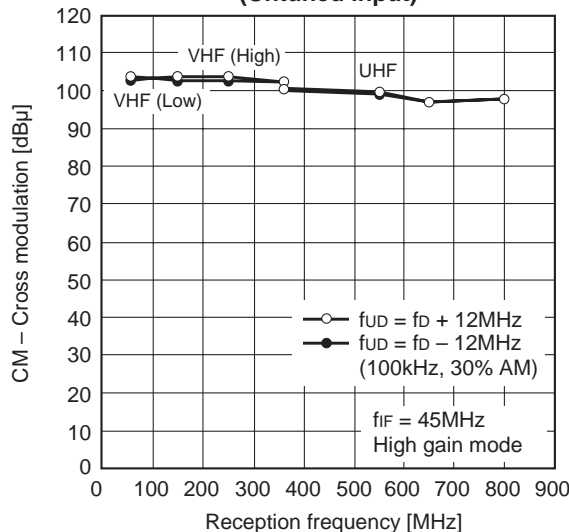
Oscillation frequency power supply fluctuation (PLL off)

Vcc + 5%
Vcc − 5%
(Vcc = 5V)

VHF (High)

VHF (Low)

UHF

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Oscillator phase noise vs. Reception frequency (untuned input)

I/O characteristics (untuned input)
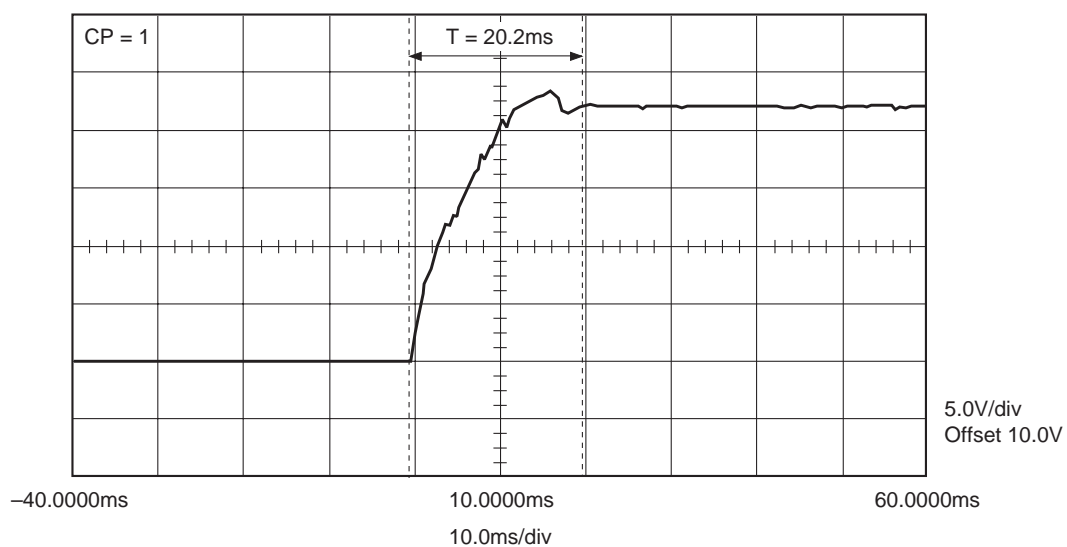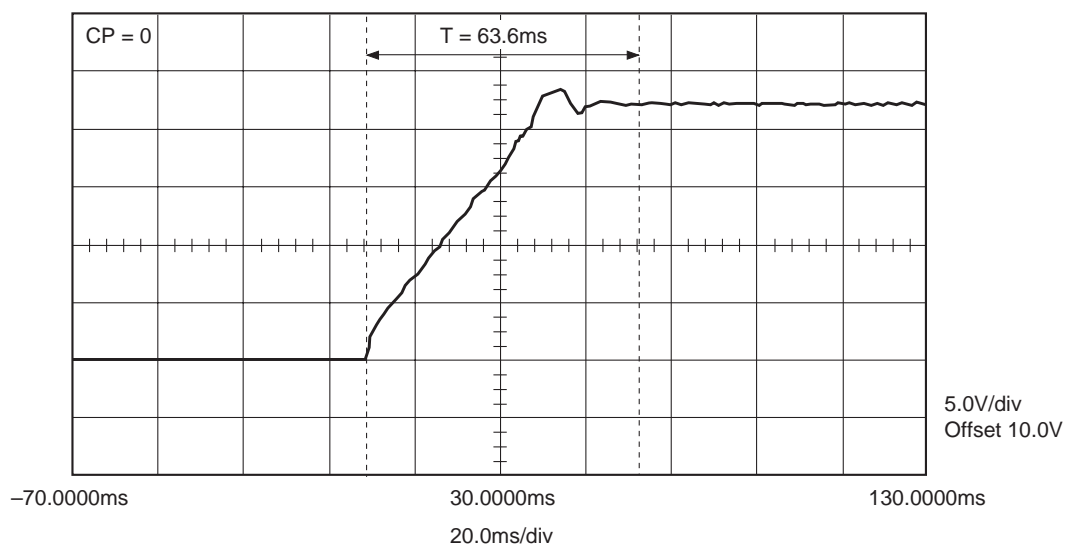

PCS beat characteristics (untuned input)
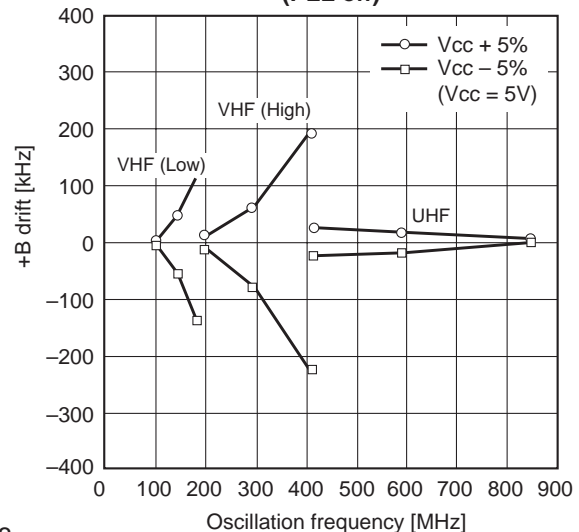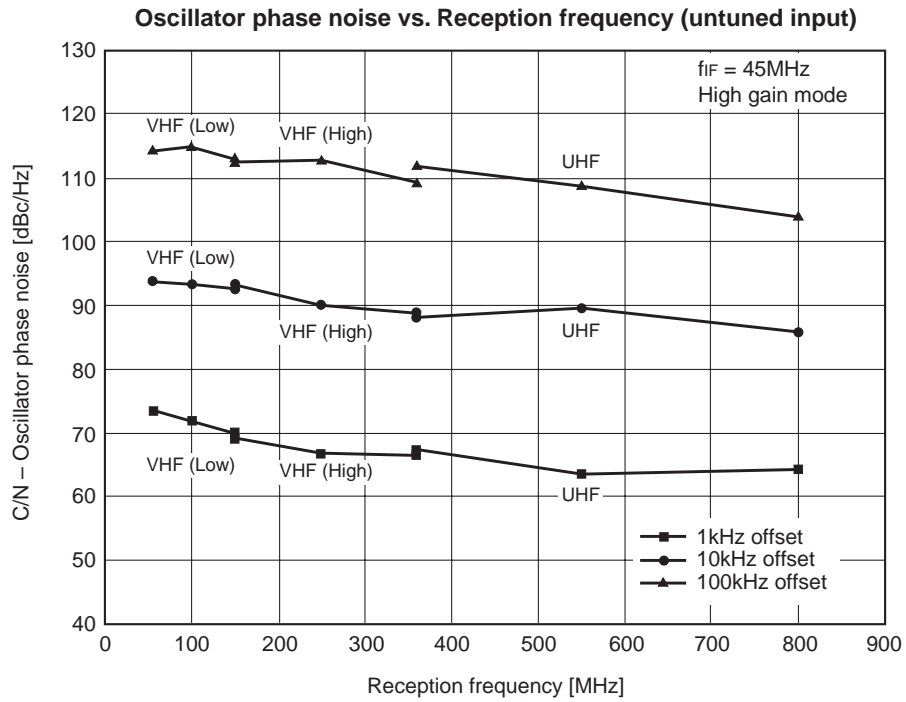
Tuning Response Time

VHF (Low) 95MHz → VHF (High) 395MHz

CP = 0

T = 47.2ms

5.0V/div
Offset 10.0V

−75.0000ms   25.0000ms   125.0000ms

20.0ms/div

CP = 1

T = 15.0ms

5.0V/div
Offset 10.0V

−40.0000ms   10.0000ms   60.0000ms

10.0ms/div

– 20 –

UHF 413MHz → UHF 847MHz

CP = 0   T = 63.6ms

5.0V/div
Offset 10.0V

−70.0000ms   30.0000ms   130.0000ms

20.0ms/div

CP = 1   T = 20.2ms

5.0V/div
Offset 10.0V

−40.0000ms   10.0000ms   60.0000ms

10.0ms/div

VHF (High) 395MHz → VHF (Low) 95MHz

CP = 0   T = 27.0ms

5.0V/div
Offset 10.0V

−110.0000ms   −10.0000ms   90.0000ms

20.0ms/div

CP = 1   T = 7.2ms

5.0V/div
Offset 10.0V

−45.0000ms   5.0000ms   55.0000ms

10.0ms/div

– 22 –

UHF 847MHz → UHF 413MHz

CP = 0   T = 35.6ms

5.0V/div
Offset 10.0V

−110.0000ms

−10.0000ms

90.0000ms

20.0ms/div

CP = 1   T = 14.4ms

5.0V/div
Offset 10.0V

−90.0000ms

10.0000ms

110.0000ms

20.0ms/div

– 23 –

IF output spectrum

REF = −10.0dBm
10dB/div

VHF (Low)
f_{RF} = 55MHz
f_{LO} = 100MHz

RF input level: −40dBm

CENTER 45.00100MHz   SPAN 50.00kHz
     RES BW 1.0kHz   VBW 10Hz   SWP 30.0s

REF = −10.0dBm
10dB/div

VHF (High)
f_{RF} = 350MHz
f_{LO} = 395MHz

RF input level: −40dBm

CENTER 45.00350MHz   SPAN 50.00kHz
     RES BW 1.0kHz   VBW 10Hz   SWP 30.0s

REF = −0.0dBm
10dB/div

UHF
f_{RF} = 800MHz
f_{LO} = 845MHz

RF input level: −40dBm

CENTER 45.00188MHz   SPAN 50.00kHz
     RES BW 1.0kHz   VBW 10Hz   SWP 30.0s

– 24 –

VHF Input Impedance

UHF Input Impedance

IF Output Impedance
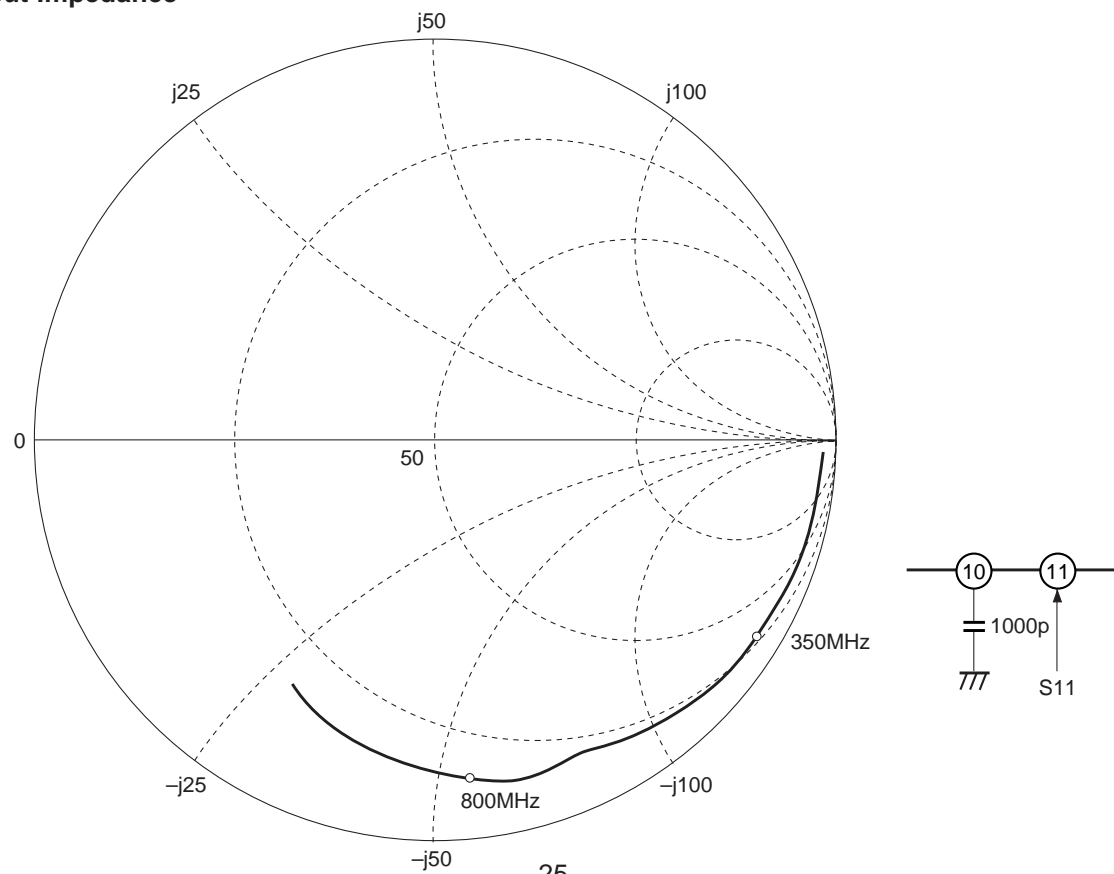
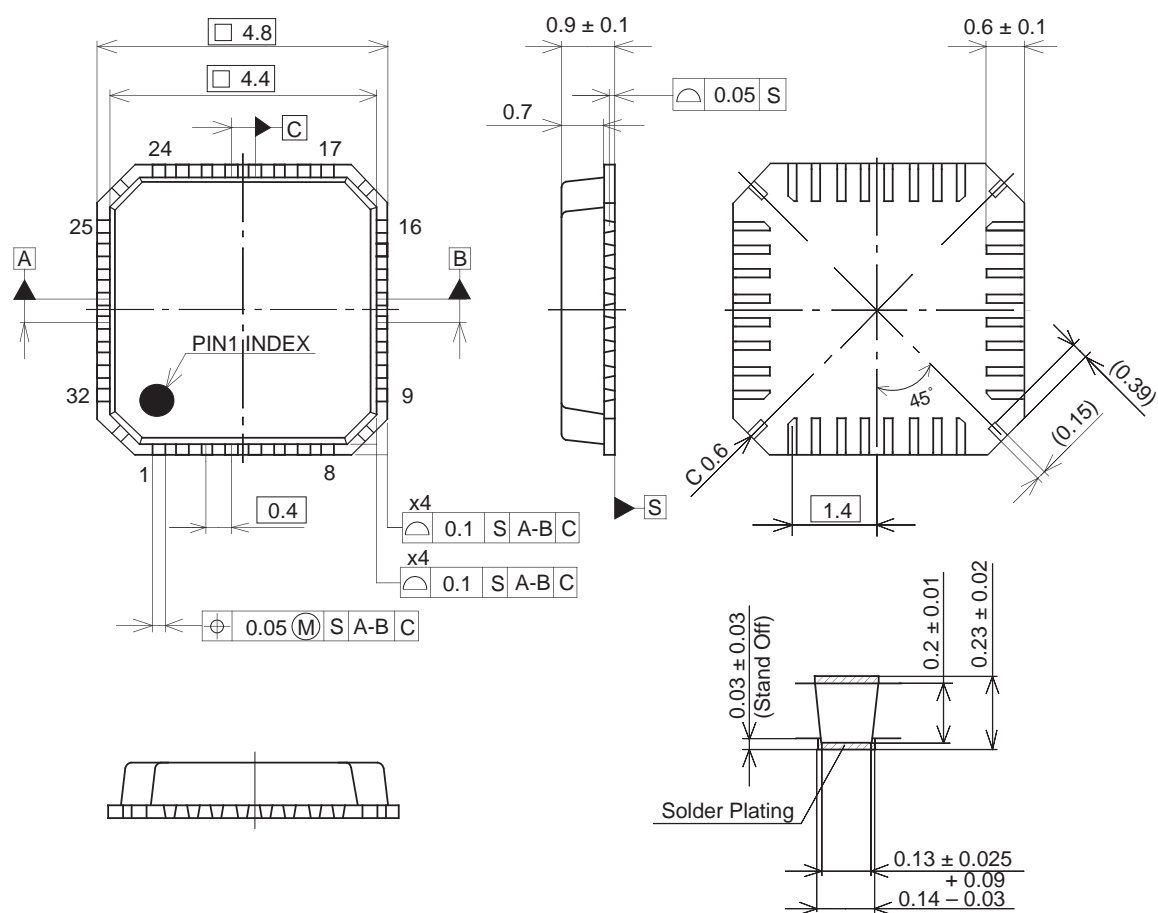**Package Outline**   Unit: mm

32PIN VQFN (PLASTIC)

NOTE: 1) The dimensions of the terminal section apply to the
ranges of 0.1mm and 0.25mm from the end of a terminal.

TERMINAL SECTION

PACKAGE STRUCTURE

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER ALLOY
PACKAGE MASS	0.05g

SONY CODE	VQFN-32P-03
EIAJ CODE	P-VQFN32-4.4X4.4-0.4
JEDEC CODE	—

LEAD PLATING SPECIFICATIONS

ITEM	SPEC.
LEAD MATERIAL	COPPER ALLOY
SOLDER COMPOSITION	Sn-Bi Bi:1-4wt%
PLATING THICKNESS	5-18μm

            Sony Corporation